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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10040272	FILING DATE 11/07/2001	CLASS 372	SUBCLASS 390	GAU 74- 288+	EXAMINER Fuqua
<p>**APPLICANTS: Timans Paul;</p>					
<p>**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CIP OF 09/747,522 12/21/2000 <i>Unassigned</i></p> <p><i>st</i></p>					
<p>** FOREIGN APPLICATIONS VERIFIED:</p> <p><i>st</i></p>					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no Verified and Acknowledged Examiners's initials <i>st</i>				ATTORNEY DOCKET NO AGX-45-CIP	
TITLE : System and process for heating semiconductor wafers by optimizing absorption of electromagnetic energy					
U.S. DEPT. OF COMM/PAT & TM-PTO-436L (Rev. 12-94)					

Best Available Copy

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner Application Examiner PREPARED FOR ISSUE	
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